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# HAT1016R

Silicon P Channel Power MOS FET  
High Speed Power Switching

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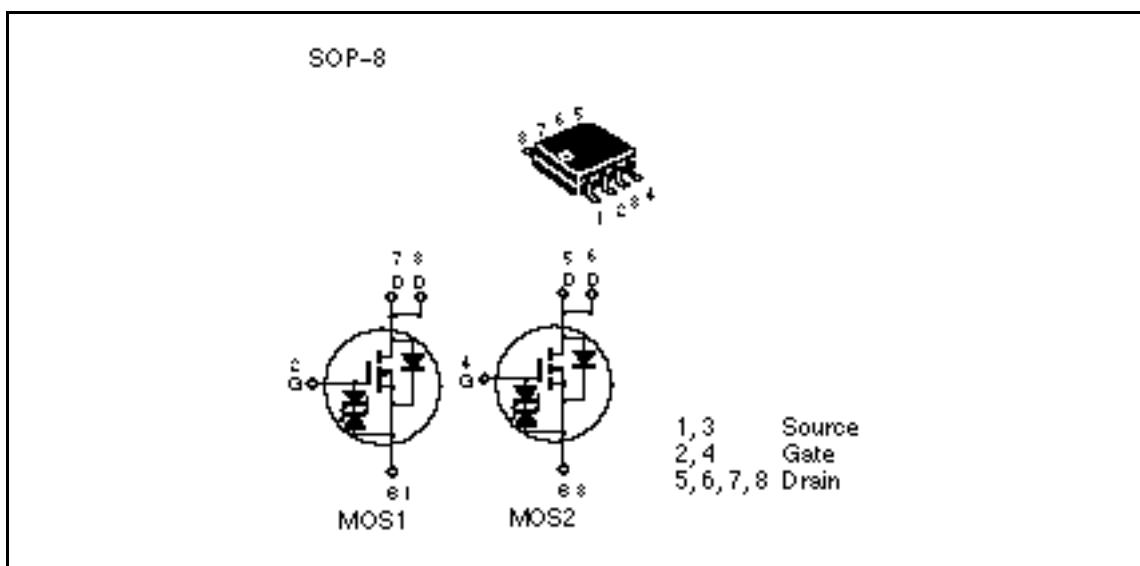
ADE-208-471 C  
4th. Edition

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## Features

- Low on-resistance
- Capable of 4 V gate drive
- Low drive current
- High density mounting

## Outline



## HAT1016R

### Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	-30	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	-4.5	A
Drain peak current	I <sub>D(pulse)</sub> <sup>*1</sup>	-36	A
Body to drain diode reverse drain current	I <sub>DR</sub>	-4.5	A
Channel dissipation	Pch <sup>*2</sup>	2	W
Channel dissipation	Pch <sup>*3</sup>	3	W
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>tstg</sub>	-55 to +150	°C

Notes: 1. PW 10μs, duty cycle 1 %

2. 1 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW 10s

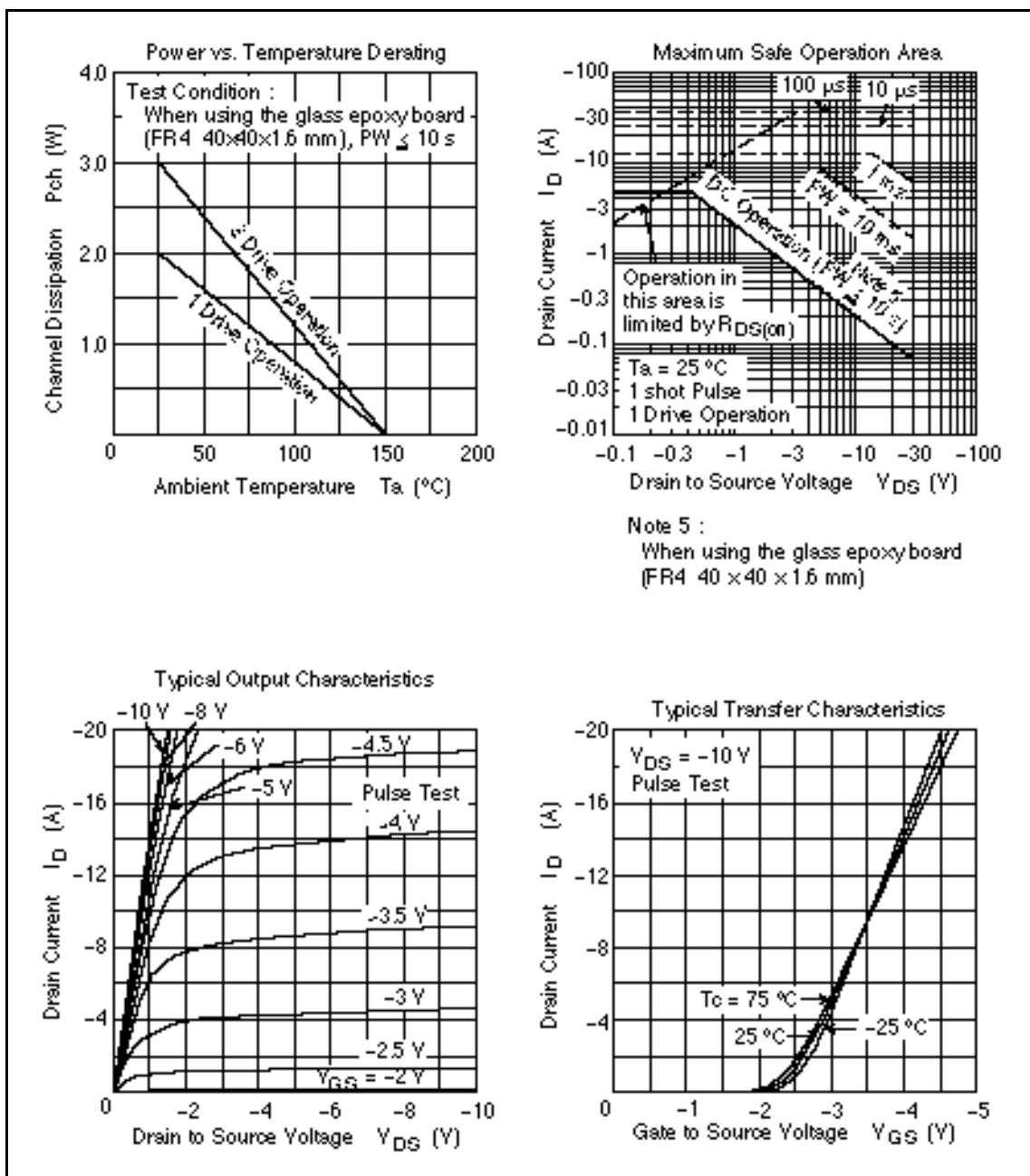
3. 2 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW 10s

### Electrical Characteristics (Ta = 25°C)

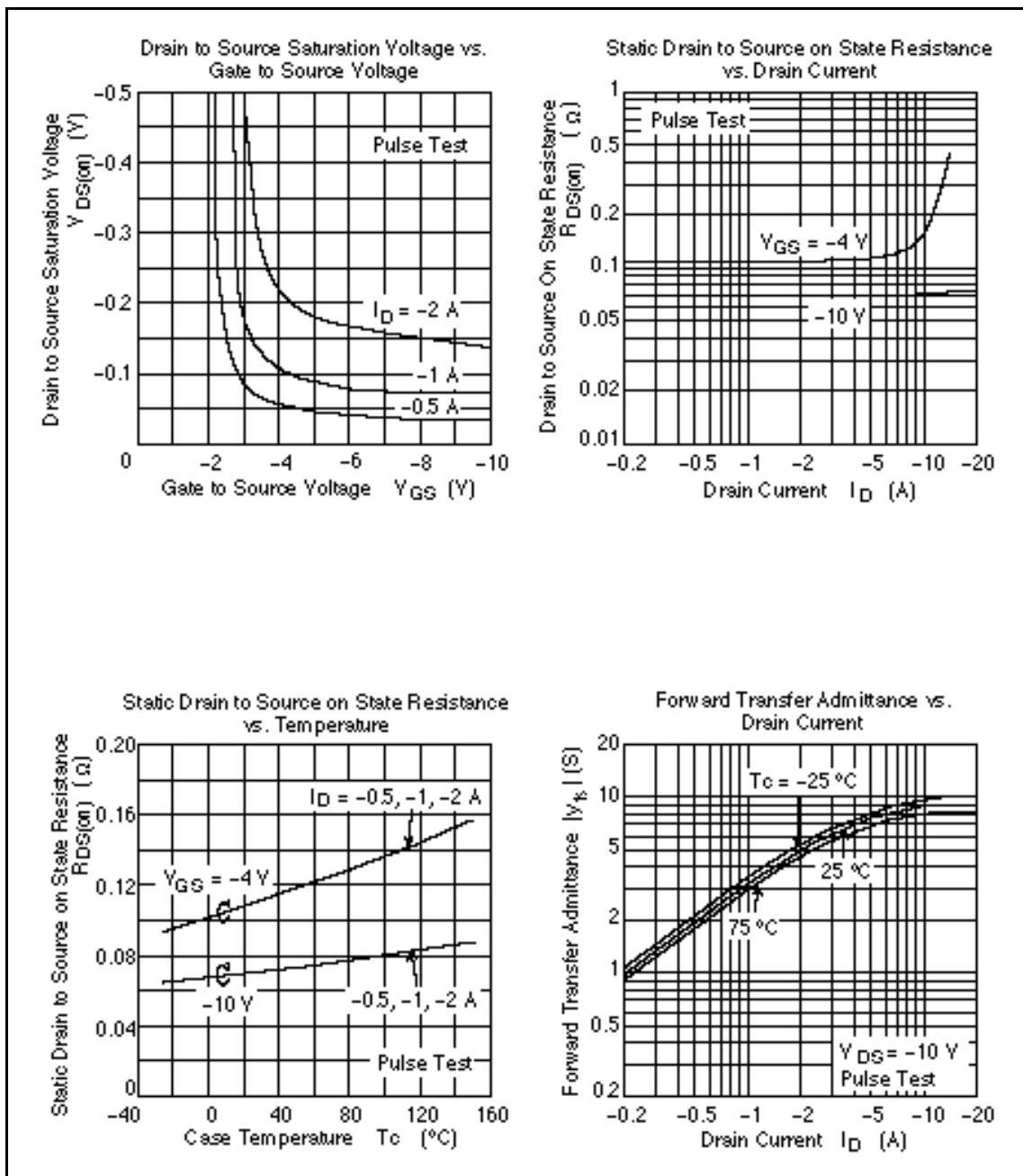
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	-30	—	—	V	I <sub>D</sub> = -10mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±20	—	—	V	I <sub>G</sub> = ±100μA, V <sub>DS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	μA	V <sub>GS</sub> = ±16V, V <sub>DS</sub> = 0
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	-10	μA	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	V <sub>GS(off)</sub>	-1.0	—	-2.5	V	V <sub>DS</sub> = -10V, I <sub>D</sub> = -1mA
Static drain to source on state resistance	R <sub>DS(on)</sub>	—	0.07	0.09		I <sub>D</sub> = -3A, V <sub>GS</sub> = -10V <sup>*1</sup>
Forward transfer admittance	y <sub>fs</sub>	4	6	—	S	I <sub>D</sub> = -3A, V <sub>DS</sub> = -10V <sup>*1</sup>
Input capacitance	C <sub>iss</sub>	—	660	—	pF	V <sub>DS</sub> = -10V
Output capacitance	C <sub>oss</sub>	—	440	—	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	C <sub>rss</sub>	—	140	—	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	—	24	—	ns	V <sub>GS</sub> = -4V, I <sub>D</sub> = -3A
Rise time	t <sub>r</sub>	—	165	—	ns	V <sub>DD</sub> = -10V
Turn-off delay time	t <sub>d(off)</sub>	—	35	—	ns	
Fall time	t <sub>f</sub>	—	70	—	ns	
Body to drain diode forward voltage	V <sub>DF</sub>	—	-0.9	-1.4	V	IF = -4.5A, V <sub>GS</sub> = 0 <sup>*1</sup>
Body to drain diode reverse recovery time	t <sub>rr</sub>	—	60	—	ns	IF = -4.5A, V <sub>GS</sub> = 0 dI/dt = 20A/μs

Note: 1. Pulse test

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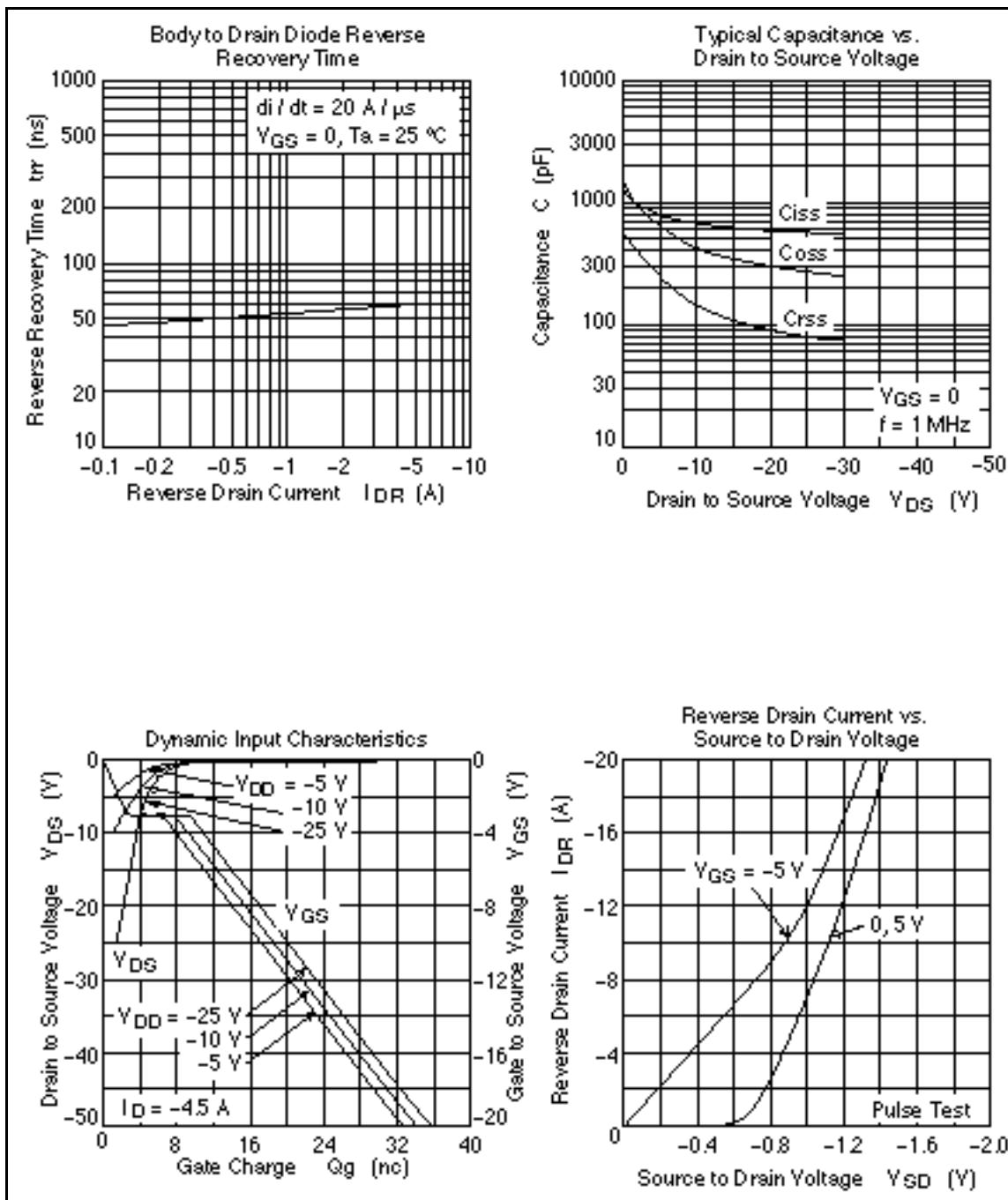
**Main Characteristics**

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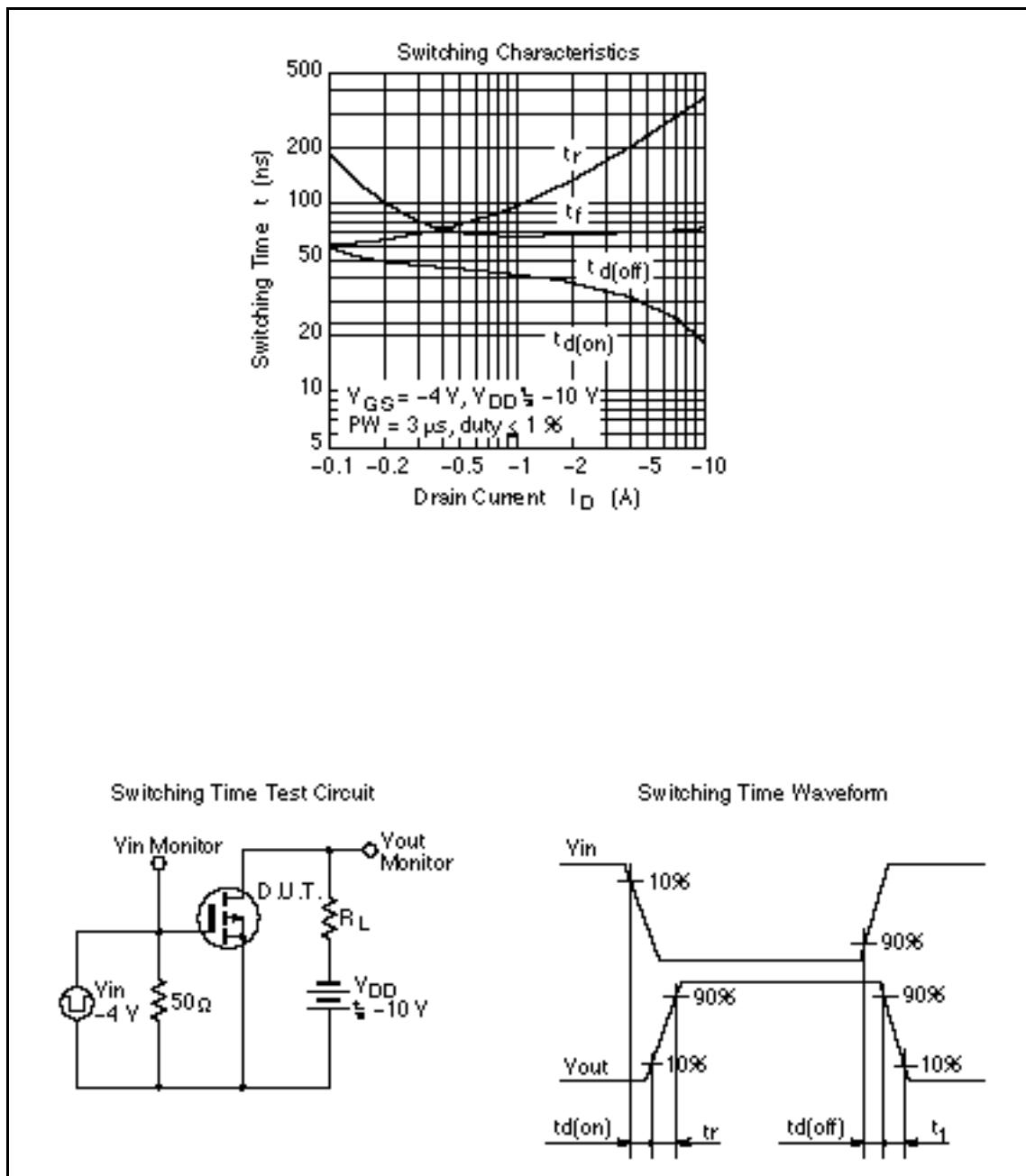
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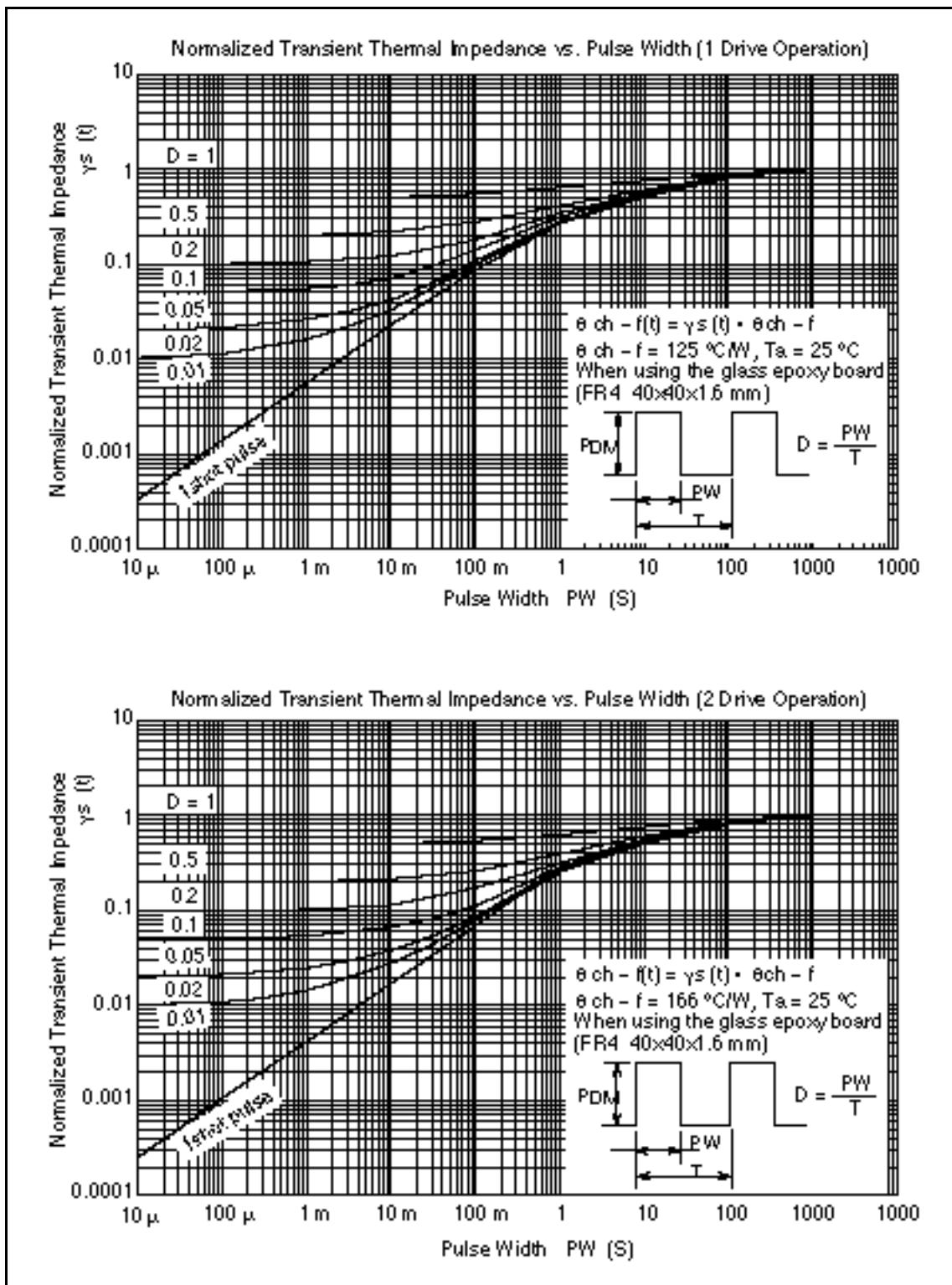


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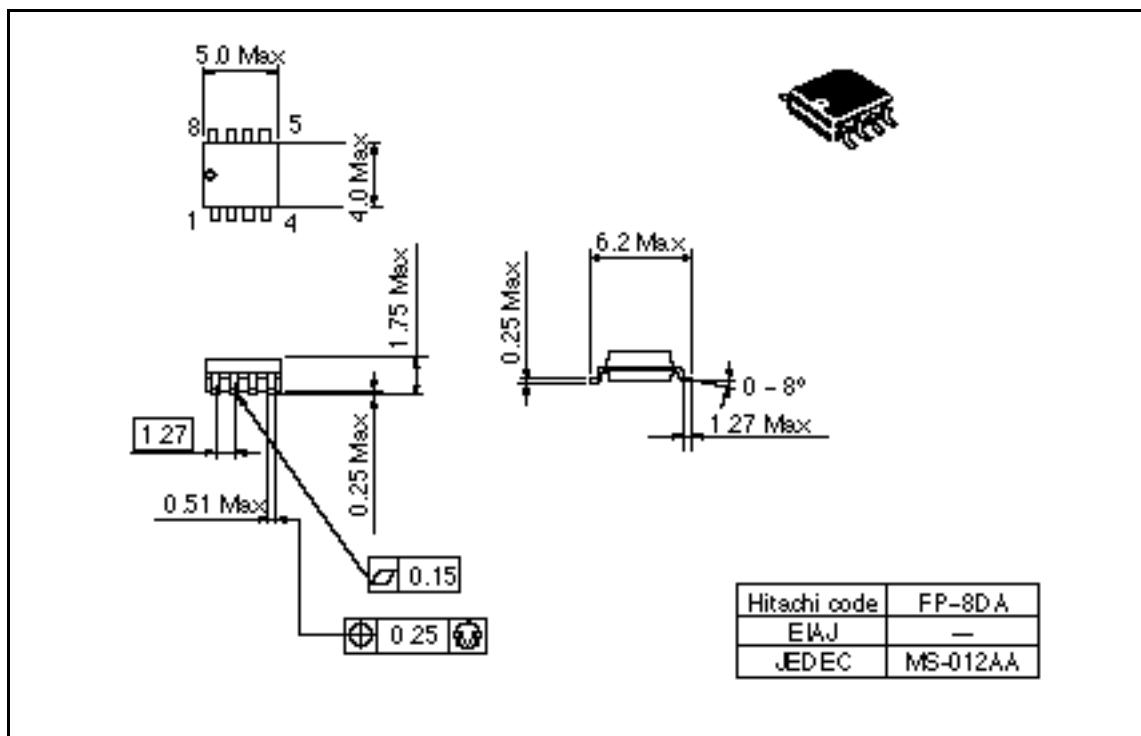
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## Package Dimensions

**Unit: mm**



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